

# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## General Description

The MAX4003 low-cost, low-power logarithmic amplifier is designed to detect the power levels of RF power amplifiers (PAs) operating from 100MHz to 2500MHz. A typical dynamic range of 45dB makes this logarithmic amplifier useful in a variety of wireless applications including cellular handset PA control, TSSI for wireless terminal devices, and other transmitter power measurements. This logarithmic amplifier provides much wider measurement range and superior accuracy than typical diode-based detectors. Excellent temperature stability is achieved over the full operating range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

The MAX4003 logarithmic amplifier is a voltage-measuring device with a typical signal range of  $-58\text{dBV}$  to  $-13\text{dBV}$ . The input signal is internally AC-coupled by an on-chip  $5\text{pF}$  capacitor in series with a  $2\text{k}\Omega$  resistance. This highpass coupling, with a corner at  $16\text{MHz}$ , sets the lowest operating frequency and allows the input signal source to be DC grounded. The MAX4003 also features a power-on delay, which holds the detector output (OUT) low for approximately  $5\mu\text{s}$  to ensure glitchless controller output.

The MAX4003 is available in an 8-bump chip-scale package (UCSP™), an 8-pin  $\mu\text{MAX}$  package, and an 8-pin thin QFN package. The device consumes  $5.9\text{mA}$  with a  $3.0\text{V}$  supply and only  $13\mu\text{A}$  when the device is in shutdown.

## Applications

Cellular Handsets (TDMA, CDMA, GPRS, GSM)  
TSSI for Wireless Terminal Devices  
Transmitter Power Measurement and Control  
RSSI for Fiber Modules

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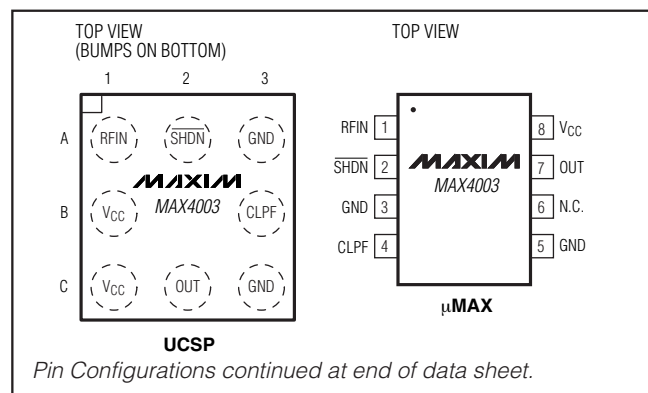
## Features

- ◆ Complete RF Detector
- ◆ Frequency Range from 100MHz to 2500MHz
- ◆ Input Range of  $-58\text{dBV}$  to  $-13\text{dBV}$   
( $-45\text{dBm}$  to  $0\text{dBm}$  into  $50\Omega$ )
- ◆ Fast Response:  $70\text{ns}$  in  $10\text{dB}$  Steps
- ◆ Low-Current Consumption:  $5.9\text{mA}$  at  $V_{\text{CC}} = 3.0\text{V}$
- ◆  $13\mu\text{A}$  (typ) Shutdown Current
- ◆ Available in 8-Bump UCSP or 8-Pin  $\mu\text{MAX}$  and Thin QFN Packages

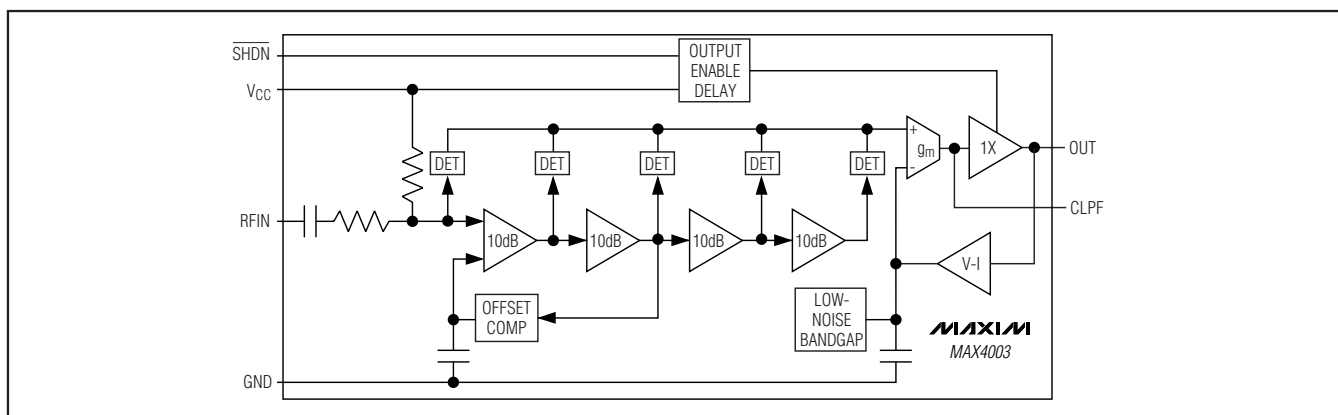
## Ordering Information

PART	TEMP RANGE	PIN/BUMP-PACKAGE	TOP MARK
MAX4003EBL-T	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	8 UCSP-8	ABV
MAX4003EUA	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	8 $\mu\text{MAX}$	—
MAX4003ETA-T	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	8 Thin QFN-EP	ADG

## Pin Configurations



## Functional Diagram



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## ABSOLUTE MAXIMUM RATINGS

V <sub>CC</sub> to GND .....	-0.3V to +5.25V	8-Pin $\mu$ MAX (derate 4.5mW/°C above +70°C) .....	362mW
SHDN, CLPF to GND .....	-0.3V to (V <sub>CC</sub> + 0.3V)	8-Pin Thin QFN (derate 24.4mW/°C above +70°C) ...	1951mW
RFIN .....	+6dBm	Operating Temperature Range .....	-40°C to +85°C
OUT Short Circuit to GND .....	10s	Junction Temperature .....	+150°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C)		Storage Temperature Range .....	-65°C to +150°C
8-Bump UCSP (derate 4.7mW/°C above +70°C) .....	379mW	Lead Temperature (soldering, 10s) .....	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

(V<sub>CC</sub> = 3.0V, V<sub>SHDN</sub> = V<sub>CC</sub>, C<sub>CLPF</sub> = 0.1 $\mu$ F, T<sub>A</sub> = -40°C to +85°C. Typical values are at T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V <sub>CC</sub>		2.7		5.0	V
Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = 5.0V		5.9	10	mA
			V <sub>SHDN</sub> = 1.8V		13	
Shutdown Input Current	I <sub>SHDN</sub>	V <sub>SHDN</sub> = 3.0V		5	20	$\mu$ A
		V <sub>SHDN</sub> = 0V		-0.01	$\pm$ 5	
Logic High Threshold Voltage	V <sub>IH</sub>		1.8			V
Logic Low Threshold Voltage	V <sub>IL</sub>				0.8	V
<b>DETECTOR OUTPUT</b>						
Voltage Range	V <sub>OUT</sub>	RFIN = 0dBm		1.45		V
		RFIN = -45dBm		0.36		
Output Voltage in Shutdown	V <sub>OUT</sub>	V <sub>SHDN</sub> = 0V		1		mV
Output-Referred Noise		f <sub>o</sub> = 150kHz		8		nV/ $\sqrt{\text{Hz}}$
Small-Signal Bandwidth	BW	C <sub>CLPF</sub> = 150pF		8		MHz
Slew Rate		V <sub>OUT</sub> = 0.36V to 1.45V, C <sub>CLPF</sub> = 150pF		5		V/ $\mu$ s

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## AC ELECTRICAL CHARACTERISTICS

( $V_{CC} = 3.0V$ ,  $V_{SHDN} = V_{CC}$ ,  $C_{CLPF} = 0.1\mu F$ ,  $f_{RF} = 100MHz$  to  $2500MHz$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

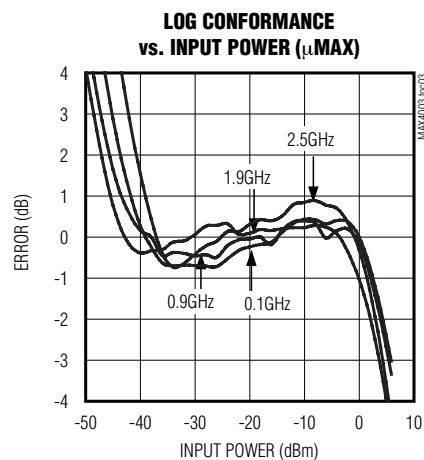
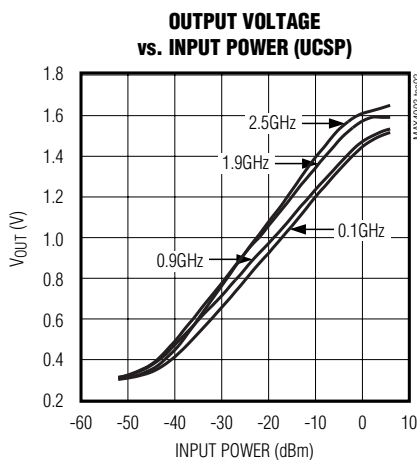
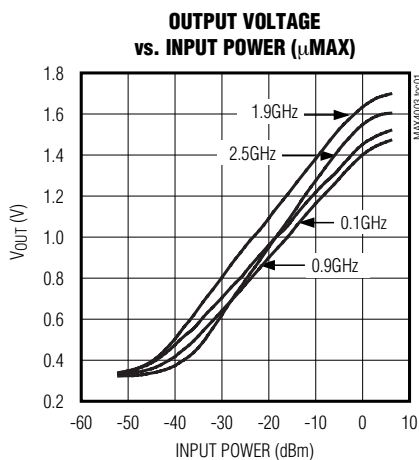
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RF Input Frequency Range	$f_{RF}$		100		2500	MHz
RF Input Voltage Range	$V_{RF}$	(Note 2)	-58		-13	dBV
Equivalent RF Input Power Range	$P_{RF}$	With $50\Omega$ termination (Note 2)	-45		0	dBm
Logarithmic Slope		$f_{RF} = 100MHz$ , $T_A = +25^{\circ}C$	22.8	25.5	28.2	mV/dB
		$f_{RF} = 100MHz$	22.5		28.5	
		$f_{RF} = 900MHz$		25.0		
		$f_{RF} = 1900MHz$		29.0		
Logarithmic Intercept	$P_X$	$f_{RF} = 100MHz$ , $T_A = +25^{\circ}C$	-62.3	-57	-51.7	dBm
		$f_{RF} = 100MHz$	-64		-50	
		$f_{RF} = 900MHz$		-57		
		$f_{RF} = 1900MHz$		-56		
RFIN Input Impedance	$R_{IN}$			2		k $\Omega$
	$C_{IN}$			0.5		pF

**Note 1:** All devices are 100% production tested at  $T_A = +25^{\circ}C$  and are guaranteed by design for  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$  as specified. All production AC tests are done at 100MHz.

**Note 2:** Typical minimum and maximum range of the detector.

## Typical Operating Characteristics

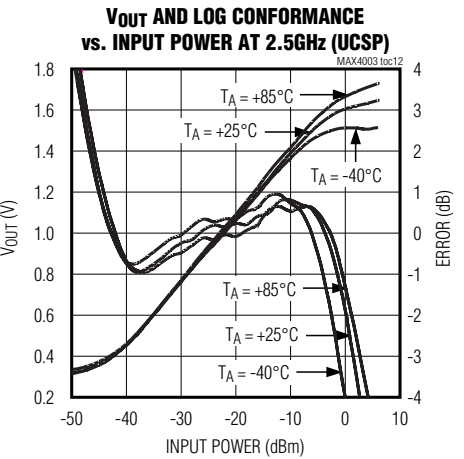
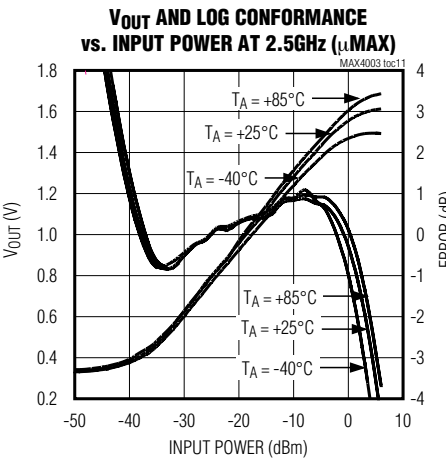
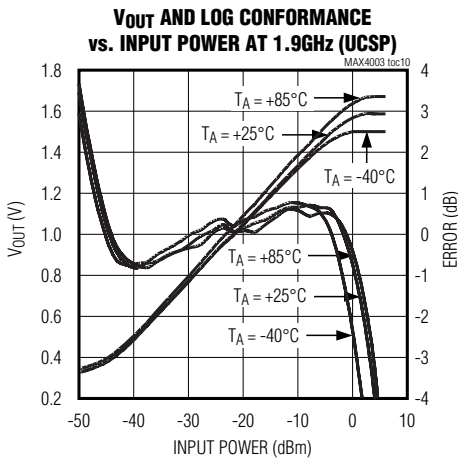
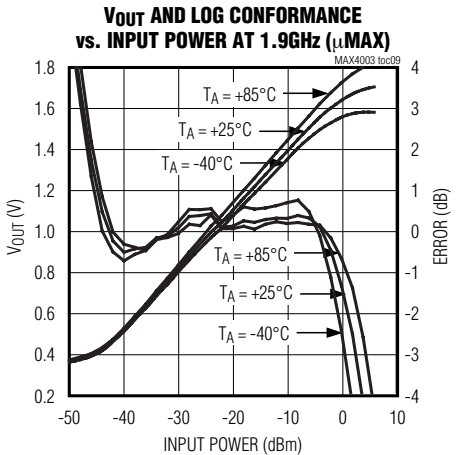
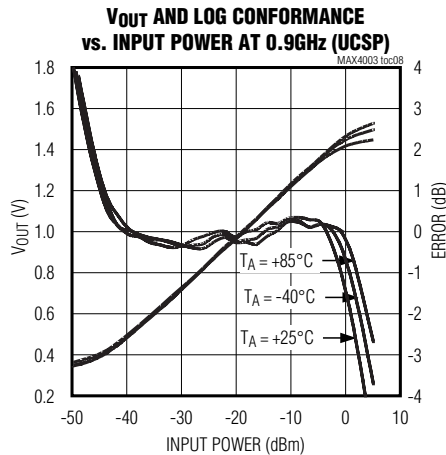
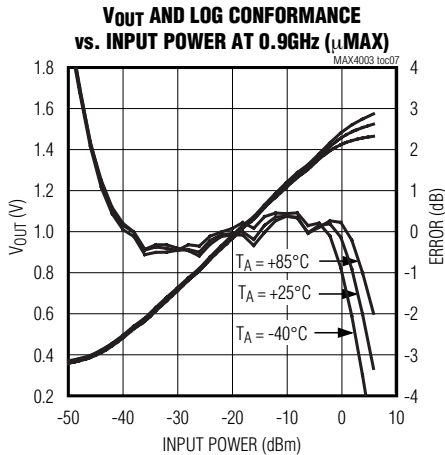
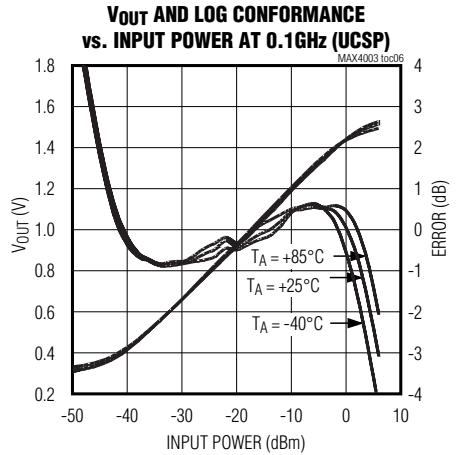
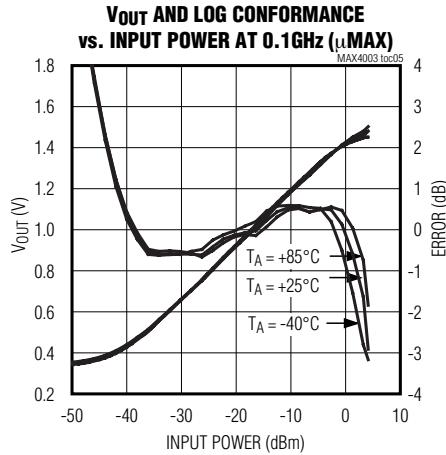
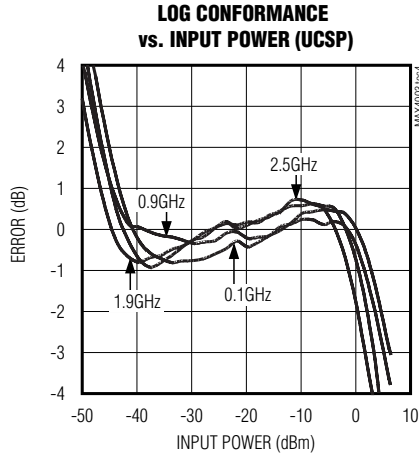
( $V_{CC} = V_{SHDN} = 3.0V$ ,  $C_{CLPF} = 0.1\mu F$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Typical Operating Characteristics (continued)

( $V_{CC} = V_{SHDN} = 3.0V$ ,  $C_{CLPF} = 0.1\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

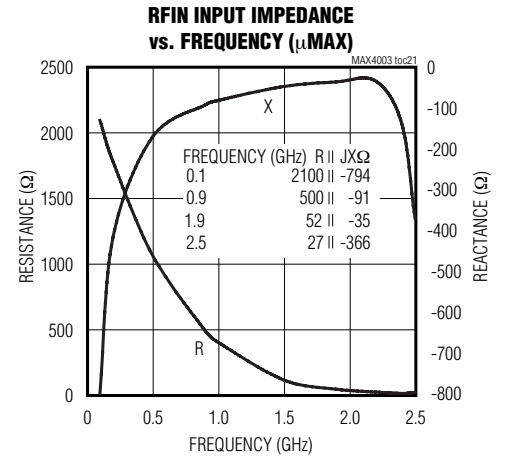
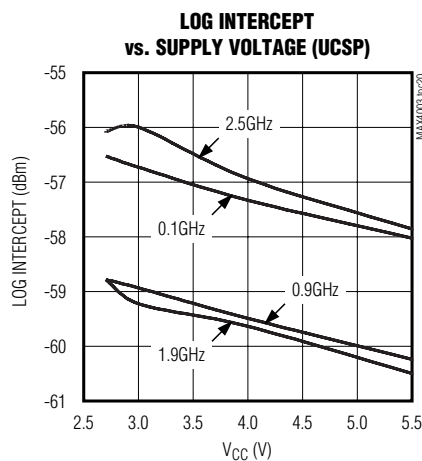
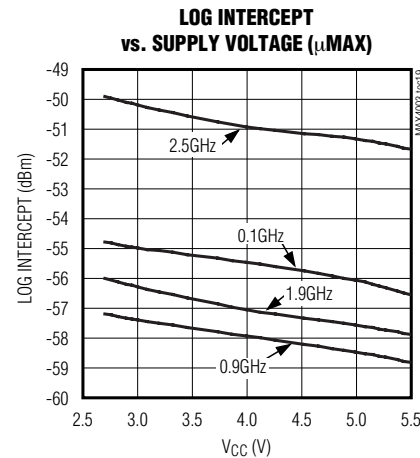
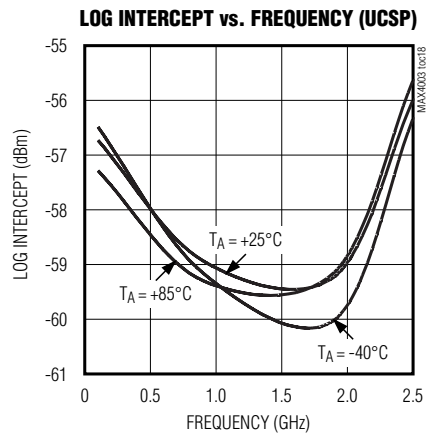
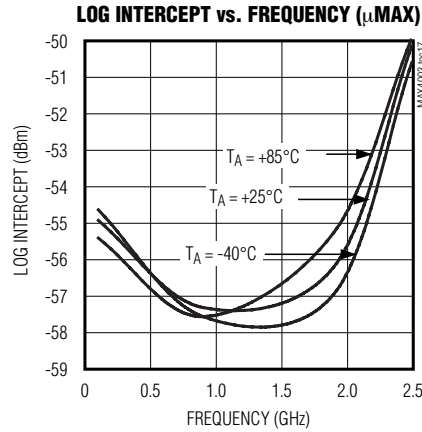
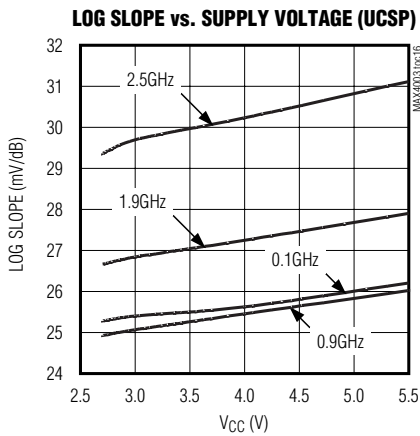
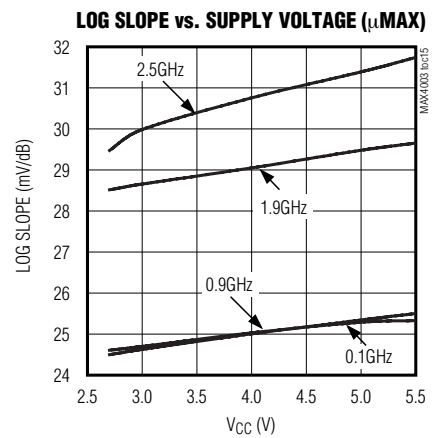
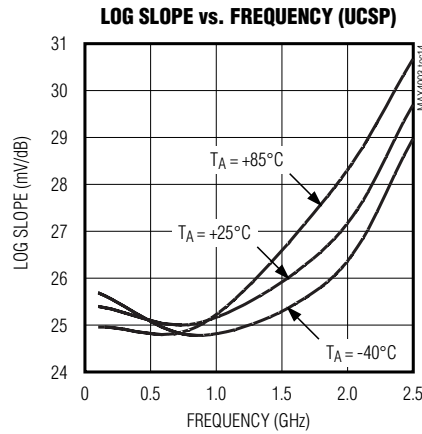
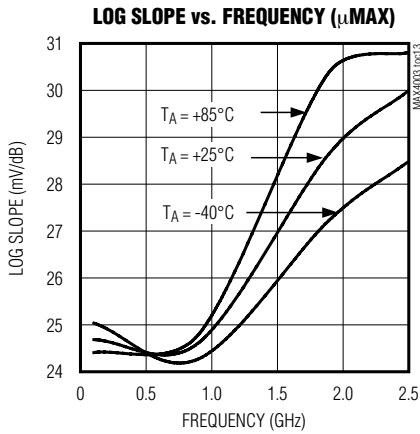


# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

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## Typical Operating Characteristics (continued)

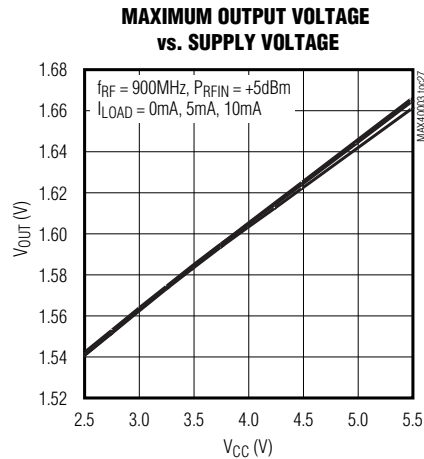
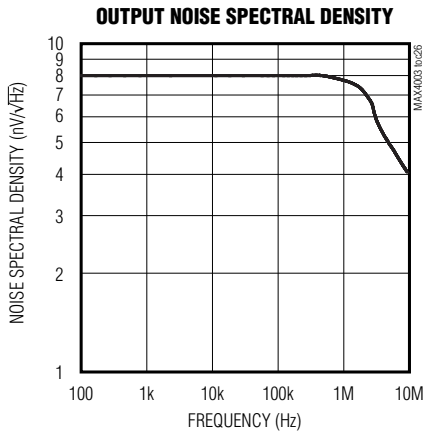
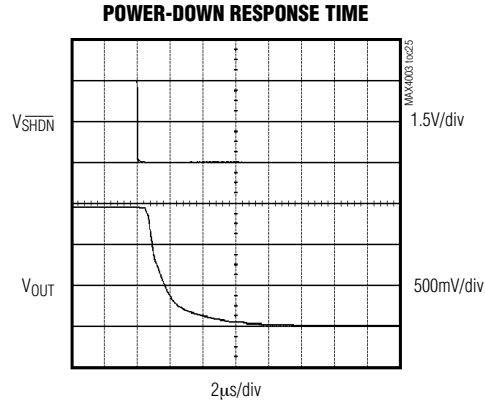
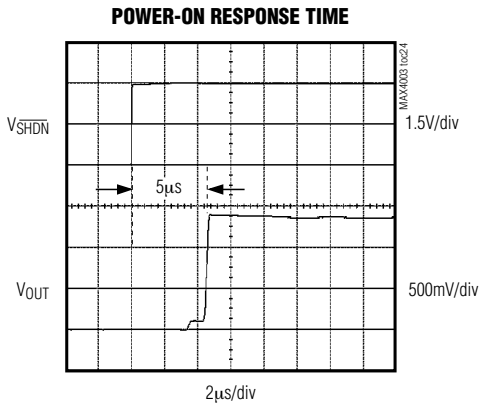
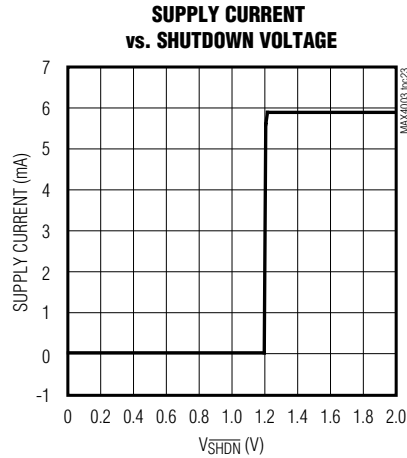
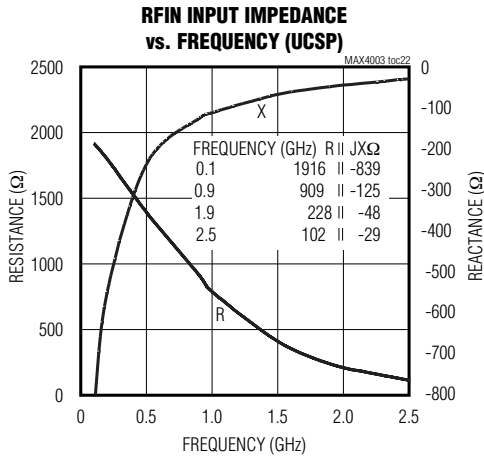
( $V_{CC} = V_{SHDN} = 3.0V$ ,  $C_{CLPF} = 0.1\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Typical Operating Characteristics (continued)

( $V_{CC} = V_{SHDN} = 3.0V$ ,  $C_{CLPF} = 0.1\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)



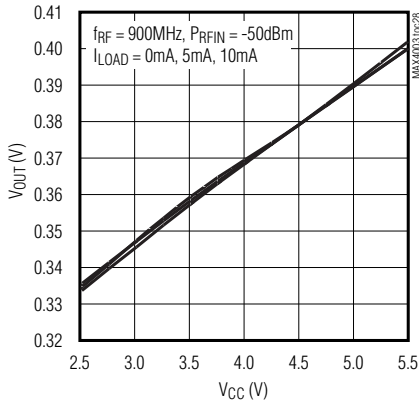
# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

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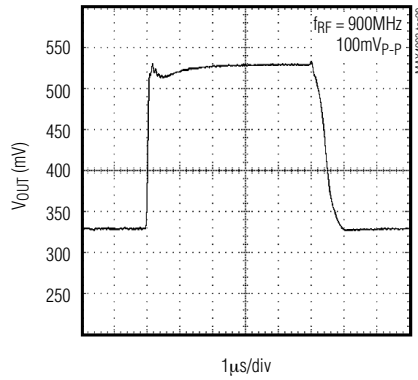
## Typical Operating Characteristics (continued)

( $V_{CC} = V_{SHDN} = 3.0V$ ,  $C_{CLPF} = 0.1\mu F$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

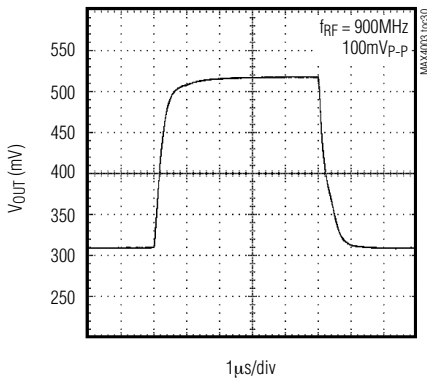
**MINIMUM OUTPUT VOLTAGE vs. SUPPLY VOLTAGE**



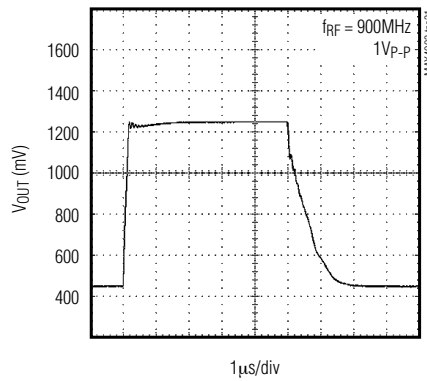
**SMALL-SIGNAL STEP RESPONSE (CCLPF = 150pF)**



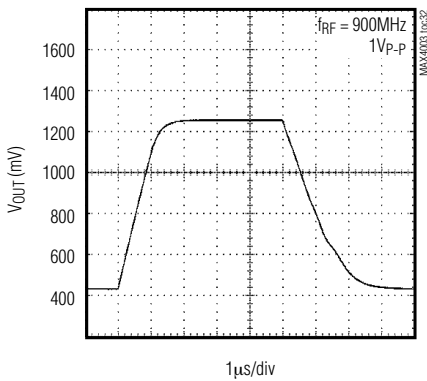
**SMALL-SIGNAL STEP RESPONSE (CCLPF = 1000pF)**



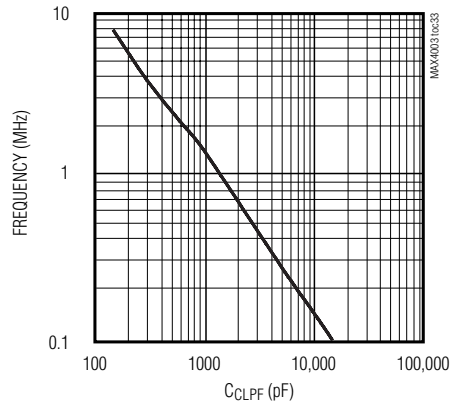
**LARGE-SIGNAL STEP RESPONSE (CCLPF = 150pF)**



**LARGE-SIGNAL STEP RESPONSE (CCLPF = 1000pF)**



**SMALL-SIGNAL BANDWIDTH vs. CCLPF**



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Pin Description

PIN		NAME	DESCRIPTION
$\mu$ MAX/ Thin QFN	UCSP		
1	A1	RFIN	RF Input. Requires off-chip $50\Omega$ impedance match.
2	A2	SHDN	Shutdown Input. A logic LOW on SHDN shuts down the entire IC.
3, 5	A3, C3	GND	Ground. Connect to PC board ground plane.
4	B3	CLPF	Lowpass Filter Connection. Connect external capacitor between CLPF and GND to set the control-loop bandwidth.
6	—	N.C.	No Connection. Leave this pin unconnected or connect to GND.
7	C2	OUT	Detector Output. Connect this buffer output to baseband ADC.
8	B1, C1	VCC	Supply Voltage. Bypass with capacitor as close to the pin as possible. The bypass capacitor must not share its ground vias with any other branches.

## Detailed Description

The MAX4003 logarithmic amplifier comprises four main amplifier/limiter stages, each with a small-signal gain of 10dB. The output stage of each amplifier/limiter stage is applied to a full-wave rectifier (detector). A detector stage also precedes the first stage. In total, five detectors, each separated by 10dB, comprise the logarithmic amplifier strip (see *Functional Diagram*).

A portion of the PA output power is coupled into RFIN of the logarithmic amplifier detector through a directional coupler, and is applied to the logarithmic amplifier strip. Each detector stage generates a rectified current, and these currents are summed to form a logarithmic function. The detected output is applied to a high-gain transconductance ( $g_m$ ) stage, which is buffered and then applied to OUT. OUT is applied to an ADC typically found in the baseband IC which, in turn, controls the

PA biasing with its DAC output (Figure 1).

In a control loop, the detector output voltage range is approximately 0.36V for the minimum input signal, -45dBm, to 1.45V at the maximum input range, 0dBm. The logarithmic intercept of the detector output with respect to the RF input can be obtained by drawing a best fit line of the Output Voltage vs. RF Input Power graph. The logarithmic slope is defined as the change in the detector output vs. the change in RF input. The MAX4003 slope at low frequencies is approximately 25.5mV/dB. Variation in temperature and supply voltage does not alter the slope significantly, as shown in the *Typical Operating Characteristics*.

## Applications Information

### Filter Capacitor and Transient Response

In general, the choice of filter only partially determines the time-domain response of a PA detector loop. However, some simple conventions may be applied to discuss transient response. A large filter capacitor,  $C_{CLPF}$ , dominates time-domain response, but the loop bandwidth remains a factor of the PA gain-control range (see *Typical Operating Characteristics*). The bandwidth is maximized at power outputs near the center of the PA's range and minimized at the low and high power levels, when the slope of the gain control curve is lowest.

A smaller valued  $C_{CLPF}$  results in an increased-loop bandwidth inversely proportional to the capacitor value. Inherent phase lag in the PA's control path, usually caused by parasitics at the OUT pin, ultimately results in the addition of complex poles in the AC loop equation. To avoid this secondary effect, experimentally determine the lowest usable  $C_{CLPF}$  for the power ampli-

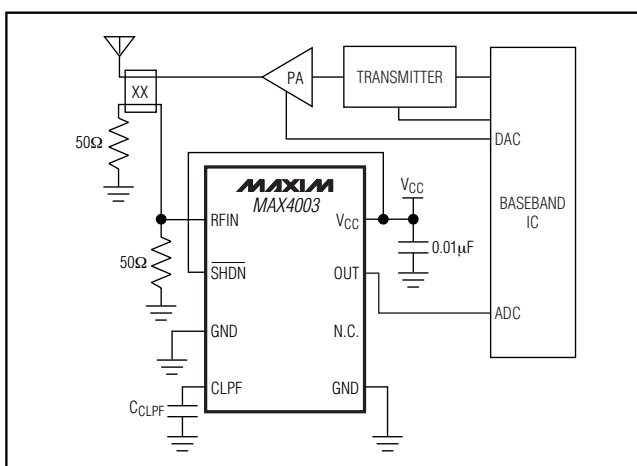


Figure 1. MAX4003 Typical Application Circuit



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

MAX4003

fier of interest. This requires full consideration of the intricacies of the PA detector control function. The worst-case condition, where the PA output is smallest (gain function is steepest), should be used because the PA control function is nonlinear. An additional zero can be added to improve loop dynamics by placing a resistor in series with CCLPF.

## Waveform Considerations

Although the input level of the MAX4003 is specified in dBm, the logarithmic amplifier actually responds to rectified voltage signals rather than a true RMS power. It is important to realize that input signals with identical root-mean-square power but with unique waveforms result in different logarithmic outputs.

Differing signal waveforms result in either an upward or downward shift in the logarithmic intercept. However, the logarithmic slope remains the same.

## Layout Considerations

As with any RF circuit, the MAX4003 circuit layout affects performance. To ensure maximum power transfer between  $50\Omega$  sources and the MAX4003 input, suitable matching networks should be implemented. The VCC input should be bypassed as close as possible to the device with multiple vias connecting the capacitor to the ground plane.

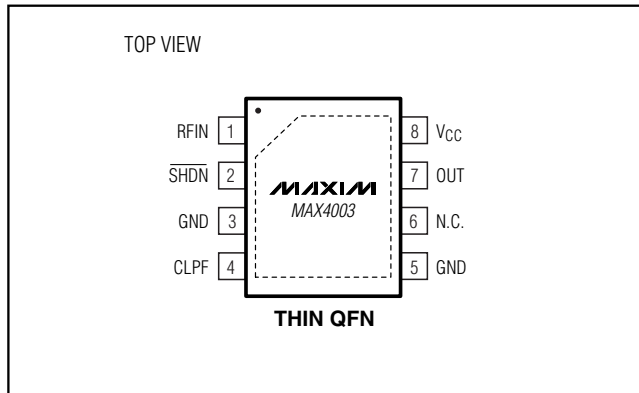
## UCSP Reliability

The UCSP represents a unique package that greatly reduces board space compared to other packages. UCSP reliability is integrally linked to the user's assembly methods, circuit board material, and usage environment. The user should closely review these areas when considering use of a UCSP. This form factor may not perform equally to a packaged product through traditional mechanical reliability tests. Performance through operating life test and moisture resistance remains uncompromised as it is primarily determined by the wafer fabrication process. Mechanical stress performance is a greater consideration for a UCSP. UCSP solder joint contact integrity must be considered since the package is attached through direct solder contact to the user's PC board. Testing done to characterize the UCSP reliability performance shows that it can perform reliably through environmental stresses. Results of environmental stress tests and additional usage data and recommendations are detailed in the UCSP application note found on Maxim's website, [www.maxim-ic.com](http://www.maxim-ic.com).

## Chip Information

TRANSISTOR COUNT: 358

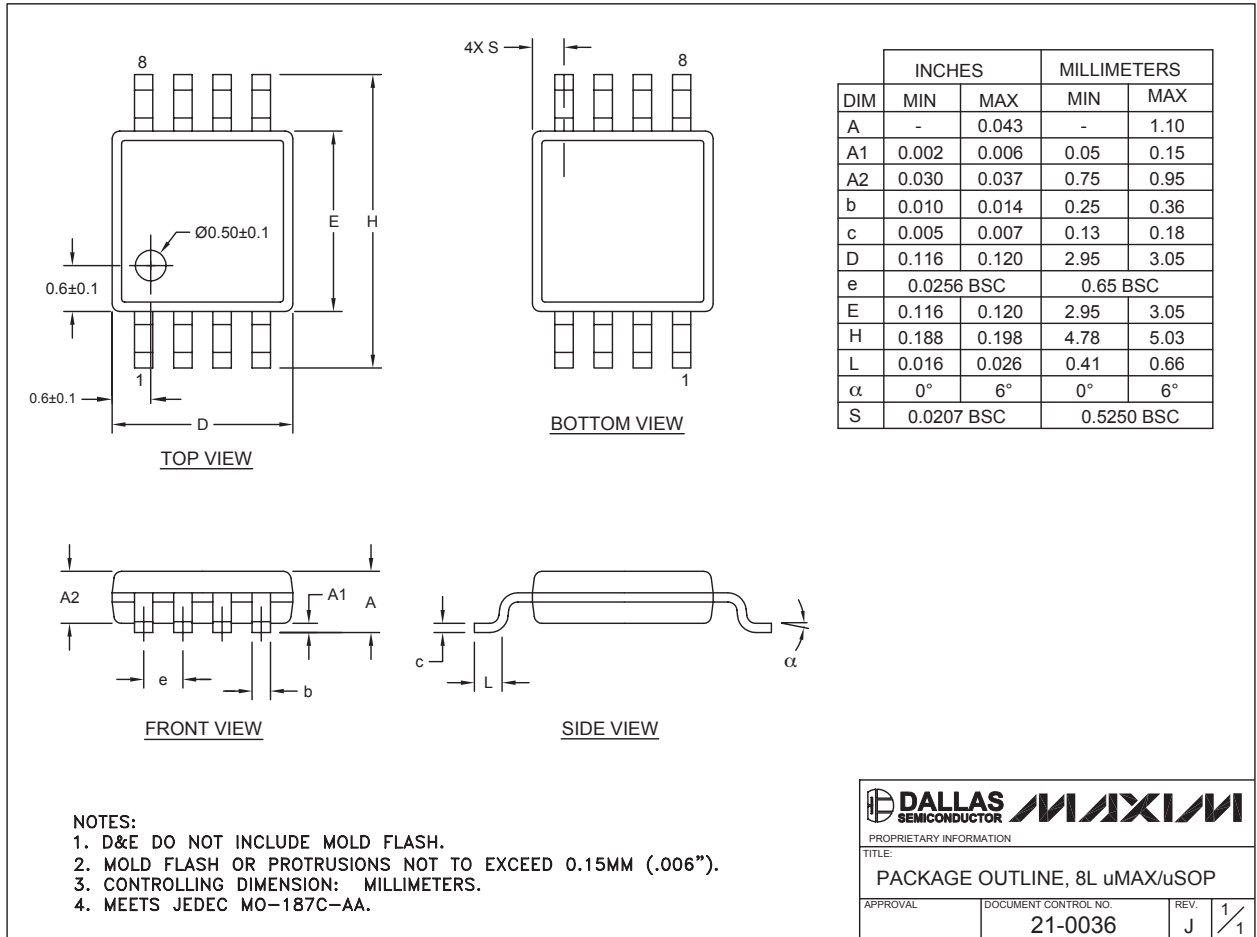
## Pin Configurations (continued)



# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)

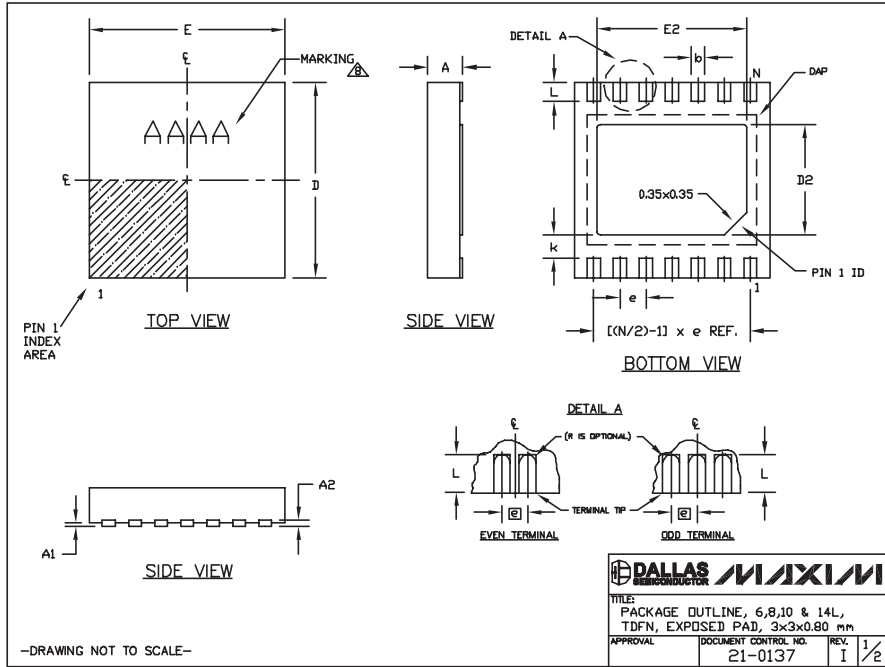


# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)

MAX4003



COMMON DIMENSIONS			PACKAGE VARIATIONS							
SYMBOL	MIN.	MAX.	PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
A	0.70	0.80	T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
D	2.90	3.10	T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
E	2.90	3.10	T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
A1	0.00	0.05	T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
L	0.20	0.40	T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
k	0.25 MIN.		T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	----	0.20±0.05	2.40 REF
A2	0.20 REF.		T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	----	0.20±0.05	2.40 REF

NOTES:  
 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.  
 2. COPLANARITY SHALL NOT EXCEED 0.08 mm.  
 3. WARPAGE SHALL NOT EXCEED 0.10 mm.  
 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).  
 5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2". AND T1433-1 & T1433-2.  
 6. "N" IS THE TOTAL NUMBER OF LEADS.  
 7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.  
 8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

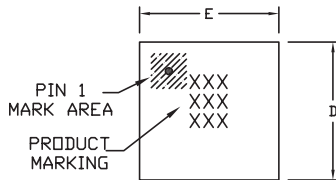
<b>DALLAS SEMICONDUCTOR</b>		<b>MAXIM</b>	
TITLE: PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm			
APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	2/2

-DRAWING NOT TO SCALE-

# 100MHz to 2500MHz, 45dB RF Detector in a UCSP

## Package Information (continued)

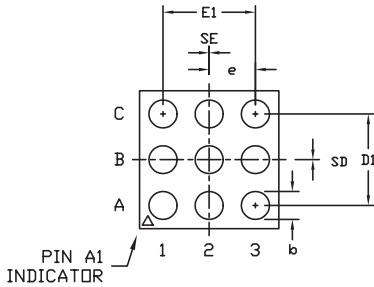
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



**TOP VIEW**

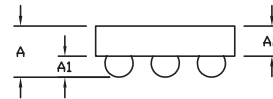
COMMON DIMENSIONS	
A	0.62±0.05-0.08
A1	0.29±0.02
A2	0.33 REF.
b	∅0.35±0.03
D1	1.00 BASIC
E1	1.00 BASIC
e	0.50 BASIC
SD	0.00 BASIC
SE	0.00 BASIC

PKG. CODE	VARIABLE DIMENSIONS		DEPOPULATED SOLDER BALLS
	D	E	
B9-1	1.52±0.05	1.52±0.05	NONE
B9-2	1.52±0.05	1.52±0.05	B2
B9-3	1.52±0.05	1.52±0.05	B1, B2, B3
B9-4	1.60±0.05	1.60±0.05	NONE
B9-5	1.60±0.05	1.60±0.05	B2
B9-6	1.60±0.05	1.60±0.05	B1, B2, B3
B9-7	1.52±0.05	1.52±0.05	A2, B1, B2, B3, C2



**BOTTOM VIEW**

- NOTES:**  
 1. ALL DIMENSIONS ARE IN MILLIMETERS.  
 2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



**SIDE VIEW**

-DRAWING NOT TO SCALE-

TITLE: PACKAGE OUTLINE, 3x3 UCSP		
APPROVAL	DOCUMENT CONTROL NO. 21-0093	REV. K 1/1

9LUCSP, 3x3.EPS

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